

Smart Power High-Side-Switch

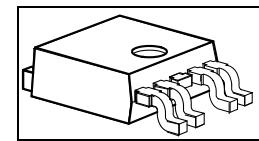
One Channel: 1 x 200mΩ

Features

- Short-circuit protection
- Current limitation
- Overload protection
- Overvoltage protection (including load dump)
- Undervoltage shutdown with autorestart and hysteresis
- Switching inductive loads
- Clamp of negative voltage at output with inductive loads
- Thermal shutdown with restart
- ESD - Protection
- Loss of GND and loss of V_{bb} protection
- Reverse battery protection with external resistor
- **Improved electromagnetic compatibility (EMC)**

Product Summary

		BTS 4501D	BTS 4141D
Overvoltage protection	$V_{bb(AZ)}$	47	47
Operating voltage	$V_{bb(on)}$	12...35	12...45
On-state resistance	R_{ON}	200	200
		mΩ	V



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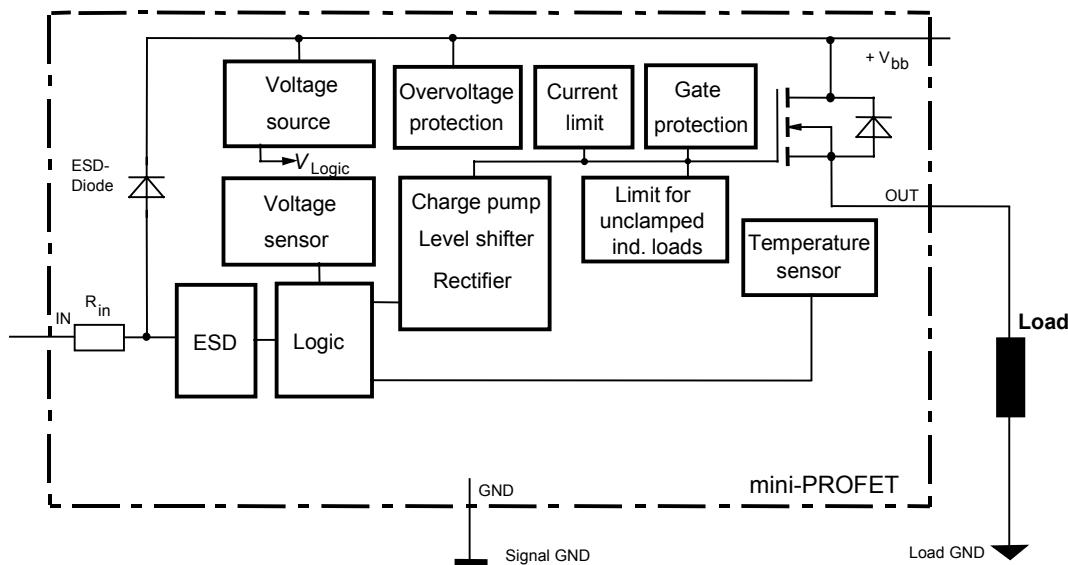
Application

- All types of resistive, inductive and capacitive loads
- Current controlled power switch for 12 V and 24 V DC applications
- Replaces electromechanical relays and discrete circuits

General Description

N channel vertical power MOSFET with charge pump ground referenced CMOS compatible input, monolithically integrated in Smart SIPMOS technology. Fully protected by embedded protection functions.

Block Diagram



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Pin	Symbol	Function
1	OUT	Output to the load
2	NC	not connected
3	V_{bb}	connected with TAB
4	GND	Logic ground
4	IN	Input, activates the power switch in case of logic high signal
TAB	V_{bb}	Positive power supply voltage



Datasheet BTS 4141D – BTS 4501D

Maximum Ratings

	BTS4501D	BTS 4141D		
Parameter	Symbol	Values	Values	Unit
at $T_j = 25^\circ\text{C}$, unless otherwise specified				
Supply voltage	V_{bb}	-0,3...48	-0,3...48	V
Load current (Short-circuit current, see page 6)	I_L	self limited	self limited	A
Continuous input voltage	V_{IN}	-5,0... V_{bb}	-5,0... V_{bb}	V
Maximum current through the input pin (DC)	I_{IN}	± 5	± 5	mA
Inductive load switch-off energy dissipation ^{1,2)} single pulse	E_{AS}	8	tbd	J
Operating temperature range	T_j	-40 ... + 125	-40 ... + 125	°C
Storage temperature range	T_{stg}	-55 ... +150	-55 ... + 150	
Max. power dissipation (DC) ¹⁾	$T_A = 25^\circ\text{C}$	P_{tot}	1.4	W
Electrostatic discharge voltage (Human Body Model) according to ANSI EOS/ESD – S5.1 – 1993 ESD STM5.1 – 1998	E_{AS}			kV
Input pin				
All other pins		± 1	± 1	
Thermal resistance junction – case: junction - ambient: ¹⁾	R_{thJC} R_{thJA}	3 60	3 60	K/W

¹⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6 cm² (one layer, 70µm thick) copper area for V_{bb} connection. PCB is vertical without blown air..

²⁾ not tested, specified by design



Datasheet BTS 4141D – BTS 4501D

Electrical Characteristics

Parameter and Conditions at $T_J = 25^\circ\text{C}$, $V_{bb} = 24\text{ V}$ unless otherwise specified	Symbol	Values			Values			Unit
		min	typ	max	min	typ	max	

Load Switching Capabilities and Characteristics

On-state resistance $T_J = 25^\circ\text{C}$, $I_L = 0,5\text{A}$ $T_J = 125^\circ\text{C}$	R_{ON}	--	0,16	0,2 0,38	--	0,15 0,27	0,2 0,32	Ω
Nominal load current Device on PCB ¹⁾	$I_{L(nom)}$	--	--	--	0,7	--	--	A
Turn-on time $T_J = -40...125^\circ\text{C}$ to 90% V_{OUT}	t_{on}	--	60	100	--	50	100	μs
Turn-off time $T_J = -40...125^\circ\text{C}$ to 10% V_{OUT}	t_{off}	--	90	150	--	75	150	μs
Slew rate on 10 to 30% V_{OUT}	dV/dt_{on}	--	2	4	--	1	2	$\text{V}/\mu\text{s}$
Slew rate off 70 to 40% V_{OUT}	$-dV/dt_{off}$	--	2	4	--	1	2	$\text{V}/\mu\text{s}$

¹⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6 cm² (one layer, 70µm thick) copper area for V_{bb} connection. PCB is vertical without blown air..



Datasheet BTS 4141D – BTS 4501D

Electrical Characteristics

Parameter and Conditions at $T_J = 25^\circ\text{C}$, $V_{bb} = 24\text{ V}$ unless otherwise specified	Symbol	Values			Values			Unit
		min	typ	max	min	typ	max	
Operating Parameters								
Operating voltage	$T_J = -40 \dots 125^\circ\text{C}$	$V_{bb(on)}$	12	--	35	12	--	45 V
Undervoltage shutdown	$T_J = -40 \dots 125^\circ\text{C}$	$V_{bb(under)}$	7	--	10,5	7	--	10,5 V
Undervoltage restart	$T_J = -40 \dots 125^\circ\text{C}$	$V_{bb(u\,rst)}$	--	--	11	--	--	11 V
Undervoltage hysteresis		$\Delta V_{bb(under)}$	--	0,4	--	--	0,5	-- V
Standby current	$T_J = -40 \dots \text{tbd}^\circ\text{C}$ $T_J = 125^\circ\text{C}^1)$	$I_{bb(off)}$	--	10	20	--	10	25 μA
Operating current, $V_{IN} = \text{high}$	$T_J = -40 \dots 25^\circ\text{C}$ $T_J = +125^\circ\text{C}$	I_{GND}	0,5 0,4	1	1,5 1,2	tbd	1	1,6
Leakage output current (included in $I_{bb(off)}$)	$T_J = -40 \dots 125^\circ\text{C}$ $V_{IN} = 0\text{ V}$	$I_{L(off)}$	--	--	2	--	tbd	10 μA

¹⁾ higher current due temperature sensor



Datasheet BTS 4141D – BTS 4501D

Electrical Characteristics

Parameter and Conditions at $T_J = 25^\circ\text{C}$, $V_{bb} = 24\text{ V}$ unless otherwise specified	Symbol	Values			Values			Unit
		min	typ	max	min	typ	max	
Initial peak short circuit current limit	$I_L(\text{lim})$	--	--	1,8	--	--	1,9	A
$T_J = -40^\circ\text{C}$			0,7	1,4	--	0,7	1,5	--
$T_J = 25^\circ\text{C}$		--	--	--	--	--	--	
$T_J = 125^\circ\text{C}$								
Output clamp (inductive load switch off) at $V_{out} = V_{bb} - V_{ON(CL)}$	$V_{ON(CL)}$	47	53	60	47	53	60	V
Overshoot protection	$V_{bb(AZ)}$	47	--	--	47	--	--	V
$T_J = -40 \dots +125^\circ\text{C}$								
Thermal overload trip temperature	T_{jt}	135	150	--	135	--	--	$^\circ\text{C}$
Thermal hysteresis	ΔT_{jt}	--	10	--	--	10	--	K

Protection Functions

		BTS 4501D			BTS 4141D		
Initial peak short circuit current limit	$I_L(\text{lim})$	--	--	1,8	--	--	1,9
$T_J = -40^\circ\text{C}$			0,7	1,4	--	0,7	1,5
$T_J = 25^\circ\text{C}$		--	--	--	--	--	--
$T_J = 125^\circ\text{C}$							
Output clamp (inductive load switch off) at $V_{out} = V_{bb} - V_{ON(CL)}$	$V_{ON(CL)}$	47	53	60	47	53	60
Overshoot protection	$V_{bb(AZ)}$	47	--	--	47	--	--
$T_J = -40 \dots +125^\circ\text{C}$							
Thermal overload trip temperature	T_{jt}	135	150	--	135	--	--
Thermal hysteresis	ΔT_{jt}	--	10	--	--	10	--

Electrical Characteristics

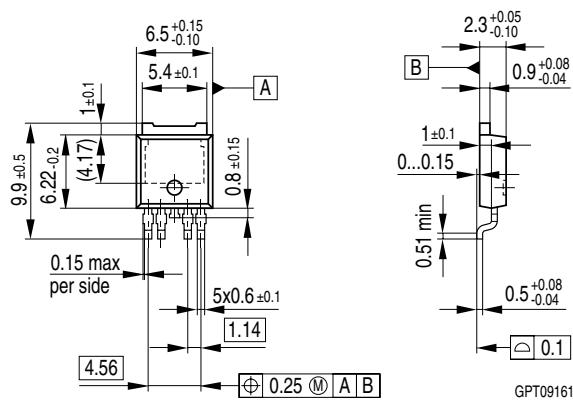
Parameter and Conditions	Symbol	Values			Values			Unit
		min	typ	max	min	typ	max	
Input								
Continuous input voltage $T_j = -40 \dots 125^\circ\text{C}$	V_{IN}	-3,0	--	V_{bb}	-3,0	--	V_{bb}	V
Input turn-on threshold voltage $T_j = -40 \dots 125^\circ\text{C}$	$V_{IN(T+)}$	--	--	2,6	--	--	3,0	V
Input turn-off threshold voltage $T_j = -40 \dots 125^\circ\text{C}$	$V_{IN(T-)}$	1,82	--	--	1,82	--	--	V
Input threshold hysteresis	$\Delta V_{IN(T)}$	--	0,1	--	--	0,3	--	V
Off state input current $T_j = -40 \dots 125^\circ\text{C}$	$I_{IN(off)}$	20	--	--	20	--	--	μA
On state input current $T_j = -40 \dots 125^\circ\text{C}$	$I_{IN(on)}$	--	--	110	--	--	110	μA
Input resistance	R_I	--	--	--	--	3	--	k Ω
Reverse Battery								
Reverse battery ¹⁾		$-V_{bb}$	--	--	--	--	--	tbd V
Continuous reverse drain current	I_S	--	--	1	--	--	tbd	A
Drain source diode voltage		$-V_{ON}$	--	--	1,2	--	0,6	V

¹⁾ Requires 150 Ω resistor in GND connection. Reverse load current (through intrinsic drain-source diode) is normally limited by the connected load.

Package:

all dimensions in mm.

SOT 223:



All metal surfaces tin plated, except area of cut.

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